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## JCK MEMS/NEMS 2024

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Deadline for  
manuscript submissions:  
**31 December 2024**

### Message from the Guest Editors

Dear Colleagues,

This Special Issue will publish selected papers from the 15th Japan-China-Korea Joint Conference on MEMS/NEMS (JCK MEMS/NEMS 2024, [www.jckmemsnems2024.com](http://www.jckmemsnems2024.com)), 19–21 September 2024 in Chengdu, China. The conference will cover the following main topics:

- Micro/Nano Electro-Mechanical Systems (M/NEMS);
- Micro/Nano-Fabrication including 3D printing;
- Micro/Nano-Actuators and Robotics;
- Micro/Nano-Chemical and Physical Sensors;
- Micro/Nano-Bio Devices and Systems;
- Micro/Nano-Electronics including Flexible Electronics;
- Micro/Nano-Enabled Wearable Devices;
- Networked Microsystems and IoT Technologies;
- Materials and Device Characterization;
- Integration and Packaging Technologies;
- Modeling and Simulation of Manufacturing Processes;
- Medical Engineering Technology.

Papers attracting the most interest at the conference, or that provide novel contributions, will be selected for publication in *Micromachines*. These papers will be peer-reviewed for validation of research results, developments and applications.

In addition, submissions from others that are not associated with this conference but with themes focusing on MEMS/NEMS technology are also welcome.





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